

SPECIFICATIONS:

- FREQUENCY: 0.5 GHz TO 18 GHz
- INSERTION LOSS: REFLECTIVE: 3.5db
ABSORPTIVE: 4.25db
- ISOLATION: 0.5 GHz TO 2 GHz: 60db
2 GHz TO 18 GHz: 70db
- VSWR: REFLECTIVE IN/OUT: 2.0:1
ABSORPTIVE IN/OUT: 2.0:1
ABSORPTIVE OUT/OFF: 2.0:1
- SPEED: RISE: 10ns TYPICAL, 15ns MAX.
FALL: 10ns TYPICAL, 15ns MAX.
DELAY ON: 75ns TYPICAL, 100ns MAX.
DELAY OFF: 75ns TYPICAL, 100ns MAX.
- POWER INPUT: (CW)+20dBm (STANDARD), +10 dBm (HIGH SPEED)
- SURVIVAL POWER: 1 WATT CW, 10 WATTS PEAK 1 usec
- CONTROL: TTL LOGIC "0"=ON "1"=OFF
- POWER SUPPLY: +5V @ 300 mA MAX.
-5V @ 75mA MAX.(REFLECTIVE)
100mA MAX.(ABSORPTIVE/NON-REFLECTIVE)

OPTIONS:

- INDEPENDENT CONTROL WITH SOLDER PIN STANDARD
- DEC-SP 3 BIT DECODER WITH SOLDER PIN
 - 10M18 10 MHz TO 18 GHz (INSERTION LOSS INCREASES BY 1.5db AT 10 MHz AND 0.5db AT 18 GHz)
 - 100M18 100 MHz TO 18 GHz (INSERTION LOSS INCREASES BY 1.5db AT 100 MHz AND 0.5db AT 18 GHz)
 - 118 1 GHz TO 18 GHz (NO CHANGE IN INSERTION LOSS)
 - 218 2 GHz TO 18 GHz (NO CHANGE IN INSERTION LOSS)
 - 412 4 GHz TO 12.4 GHz (NO CHANGE IN INSERTION LOSS)
 - 618 6 GHz TO 18 GHz (NO CHANGE IN INSERTION LOSS)
 - 1218 12 GHz TO 18 GHz (NO CHANGE IN INSERTION LOSS)
 - 100M20 100 MHz TO 20 GHz (INSERTION LOSS INCREASES BY 1.5db AT 100 MHz AND 1.0db AT 20 GHz)
 - 220 2 GHz TO 20 GHz (INSERTION LOSS INCREASES BY 1.0db AT 20 GHz)
 - 1020 10 GHz TO 20 GHz (INSERTION LOSS INCREASES BY 1.0db AT 20 GHz)
 - B01 -12V POWER SUPPLIES
 - B02 -15V POWER SUPPLIES
 - B03 REVERSE LOGIC "1"=ON "0"=OFF
 - B04 DRIVERLESS, CURRENT CONTROLLED
 - B05 HIGH SPEED, TURNON/TURNOFF 25 nsec MAXIMUM WHEN APPLICABLE
 - B06 HIGH POWER - SPECIFY CW POWER, PEAK POWER, PULSE WIDTH, DUTY CYCLE, RF FREQUENCY AND BANDWIDTH
 - B07 CUSTOM DESIGNED PRODUCT- SPECIFY INITIALS OF CUSTOMER
 - B08 LOW VIDEO TRANSIENTS - SPECIFY VIDEO BANDWIDTH
 - B09 LOW INSERTION LOSS VERSION
 - B10 HIGHER ISOLATION VERSION
 - B11 0.40" THICK VERSION

ENVIRONMENTAL RATINGS:

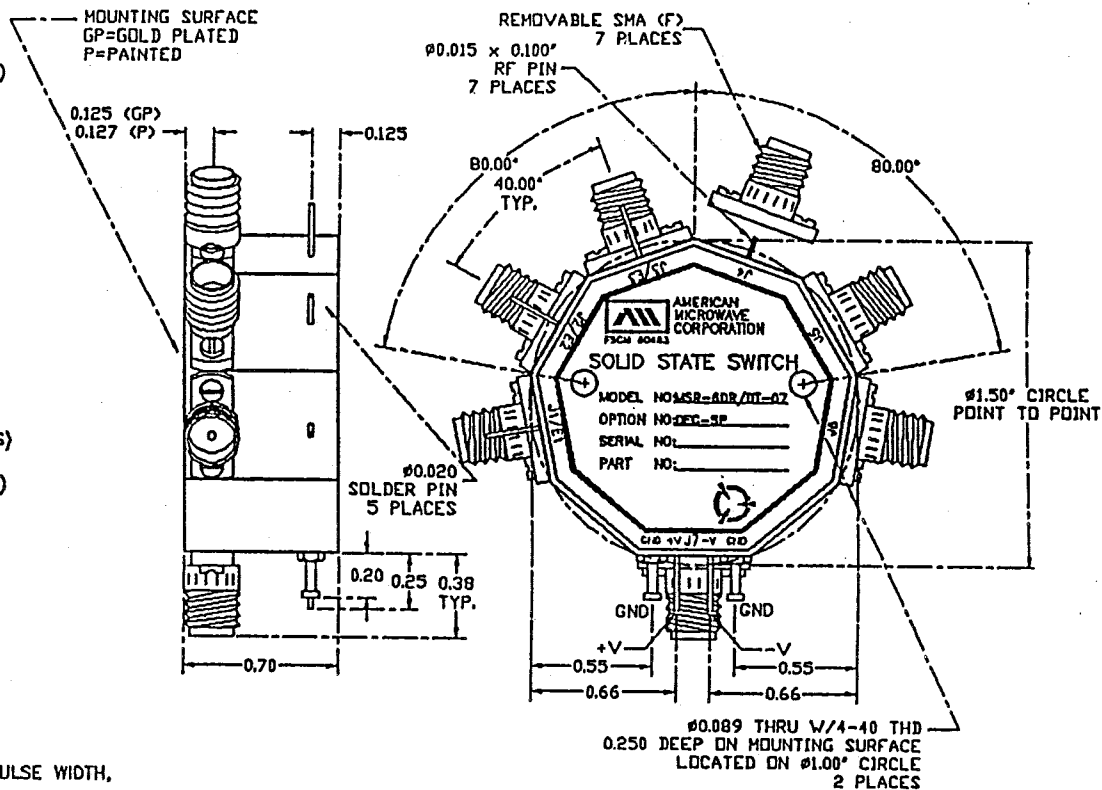
- TEMPERATURE: -55°C TO +85°C (OPERATING)
-65°C TO +125°C (STORAGE)
- HUMIDITY: MIL-STD-202F, METHOD 103B COND. B
- SHOCK: MIL-STD-202F, METHOD 213B COND. B
- VIBRATION: MIL-STD-202F, METHOD 204D COND. B
- ALTITUDE: MIL-STD-202F, METHOD 105C COND. B
- TEMPERATURE CYCLE: MIL-STD-202F, METHOD 107D COND. A

NOTE: THE ABOVE SPECIFICATIONS ARE SUBJECT TO CHANGE OR REVISION

ALL DIMENSIONS ARE IN INCHES
TOLERANCES:

- X.XX ±0.020
- X.XXX ±0.010

REVISIONS				
DATE	REV.	DESCRIPTION	DATE	APPROVED
	A	ORIGINAL RELEASE	8/13/97	



NOTE:

- DR=WITH DRIVER, REFLECTIVE
- DT=WITH DRIVER, NON-REFLECTIVE/ABSORPTIVE

PART NO.		AMERICAN MICROWAVE CORPORATION FREDERICK, MARYLAND		
APPROVALS	DATE	TITLE		
DRAWN <i>WSP</i>	8/13/97	OUTLINE DRAWING		
CHECKED <i>V. Meade</i>	11/7/97	MSR-6DR/DT-07-DEC-SP		
ISSUED		REFLECTIVE OR NON-REFLECTIVE/ABSORPTIVE SOLID STATE SWITCH		
SIZE	FROM NO.	DWG NO.	REV.	
A	60483	100-4195-2	A	
SCALE N/S		7 1 of 1		